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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
0084869	03/01/2002	456 528	2560	1712	AYLWARD, D

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**CONTINUING DATA VERIFIED: None Dec

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** FOREIGN APPLICATIONS VERIFIED: None Dec

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	1988.EEM
Verified and Acknowledged Examiners's initials <i>Dec</i>		
TITLE : Underfill encapsulant for wafer packaging and method for its application		

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
9-16-03		Total Claims 31	Print Claim for O.G. 1
ISSUE FEE		DRAWING	
Amount Due \$1600	Date Paid	Sheets Drwg. None	Figs. Drwg. None
<input type="checkbox"/> TERMINAL DISCLAIMER		Print Fig. None	
Robert Dawson Supervisory Patent Examiner Technology Center 1700 Primary Examiner <i>Robert Dawson</i> PREPARED FOR ISSUE		Applicant Examiner <i>Robert Dawson</i> 9/11/03	
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